

501.20289RC6

2814

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicants: H. MAEJIMA, et al.

Serial No: 09/704,529

Filed: November 3, 2000

Title: WAFER HAVING CHAMFERED BEND PORTIONS IN THE

JOINT REGIONS BETWEEN THE CONTOUR OF THE WAFER

AND THE CUT-AWAY PORTION OF THE WAFER

Group: 2814

Examiner: L. PHAM

<u>AMENDMENT</u>

Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

March 7, 2005

Sir:

In response to the Office Action dated September 9, 2004, please amend the above-identified application as listed below and as set forth on the following pages:

Amendments to the Claims

Remarks are included following the amendments